

# MBRB1545CTG, SBRB1545CTG

## SWITCHMODE Power Rectifier

### D<sup>2</sup>PAK Surface Mount Power Package

The D<sup>2</sup>PAK Power Rectifier employs the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

#### Features

- Center-Tap Configuration
- Guardring for Stress Protection
- Low Forward Voltage
- 175°C Operating Junction Temperature
- Epoxy Meets UL 94, V-0 @ 0.125 in
- Short Heatsink Tab Manufactured – Not Sheared
- Similar in Size to the Industry Standard TO220 Package
- SBRB Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant\*

#### Mechanical Characteristics

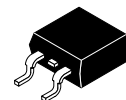
- Case: Epoxy, Molded, Epoxy Meets UL 94, V-0
- Weight: 1.7 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Device Meets MSL1 Requirements
- ESD Ratings:
  - ♦ Machine Model = C (> 400 V)
  - ♦ Human Body Model = 3B (> 8000 V)



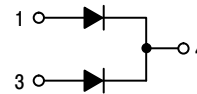
**ON Semiconductor®**

<http://onsemi.com>

### SCHOTTKY BARRIER RECTIFIER 15 AMPERES 45 VOLTS



**D<sup>2</sup>PAK  
CASE 418B  
STYLE 3**



#### MARKING DIAGRAM



B1545 = Device Code  
A = Assembly Location  
Y = Year  
WW = Work Week  
G = Pb-Free Package  
AKA = Diode Polarity

#### ORDERING INFORMATION

| Device        | Package                         | Shipping <sup>†</sup> |
|---------------|---------------------------------|-----------------------|
| MBRB1545CTG   | D <sup>2</sup> PAK<br>(Pb-Free) | 50 Units/Rail         |
| SBRB1545CTG   | D <sup>2</sup> PAK<br>(Pb-Free) | 50 Units/Rail         |
| MBRB1545CTT4G | D <sup>2</sup> PAK<br>(Pb-Free) | 800/Tape & Reel       |
| SBRB1545CTT4G | D <sup>2</sup> PAK<br>(Pb-Free) | 800/Tape & Reel       |

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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## MAXIMUM RATINGS (Per Leg)

| Rating                                                                                                      | Symbol                          | Value       | Unit             |
|-------------------------------------------------------------------------------------------------------------|---------------------------------|-------------|------------------|
| Peak Repetitive Reverse Voltage<br>Working Peak Reverse Voltage<br>DC Blocking Voltage                      | $V_{RRM}$<br>$V_{RWM}$<br>$V_R$ | 45          | V                |
| Average Rectified Forward Current<br>(Rated $V_R$ , $T_C = 167^\circ\text{C}$ ) Total Device                | $I_{F(AV)}$                     | 7.5<br>15   | A                |
| Peak Repetitive Forward Current<br>(Rated $V_R$ , Square Wave, 20 kHz, $T_C = 166^\circ\text{C}$ )          | $I_{FRM}$                       | 15          | A                |
| Non-Repetitive Peak Surge Current<br>(Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz) | $I_{FSM}$                       | 150         | A                |
| Peak Repetitive Reverse Surge Current (2.0 $\mu\text{s}$ , 1.0 kHz)                                         | $I_{RRM}$                       | 1.0         | A                |
| Storage Temperature Range                                                                                   | $T_{stg}$                       | -65 to +175 | $^\circ\text{C}$ |
| Operating Junction Temperature (Note 1)                                                                     | $T_J$                           | -65 to +175 | $^\circ\text{C}$ |
| Voltage Rate of Change (Rated $V_R$ )                                                                       | $dv/dt$                         | 10,000      | V/ $\mu\text{s}$ |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. The heat generated must be less than the thermal conductivity from Junction-to-Ambient:  $dP_D/dT_J < 1/R_{\theta JA}$ .

## THERMAL CHARACTERISTICS (Per Leg)

| Characteristic                                                         | Symbol                             | Value     | Unit                      |
|------------------------------------------------------------------------|------------------------------------|-----------|---------------------------|
| Thermal Resistance<br>Junction to Case<br>Junction to Ambient (Note 2) | $R_{\theta JC}$<br>$R_{\theta JA}$ | 2.0<br>50 | $^\circ\text{C}/\text{W}$ |

2. When mounted using minimum recommended pad size on FR-4 board.

## ELECTRICAL CHARACTERISTICS (Per Leg)

| Characteristic                                                                                                                                                                                       | Symbol | Value                | Unit |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------|----------------------|------|
| Maximum Instantaneous Forward Voltage (Note 3)<br>( $i_F = 7.5$ Amps, $T_J = 125^\circ\text{C}$ )<br>( $i_F = 15$ Amps, $T_J = 125^\circ\text{C}$ )<br>( $i_F = 15$ Amps, $T_J = 25^\circ\text{C}$ ) | $V_F$  | 0.57<br>0.72<br>0.84 | V    |
| Maximum Instantaneous Reverse Current (Note 3)<br>(Rated dc Voltage, $T_J = 125^\circ\text{C}$ )<br>(Rated dc Voltage, $T_J = 25^\circ\text{C}$ )                                                    | $i_R$  | 15<br>0.1            | mA   |

3. Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$ .

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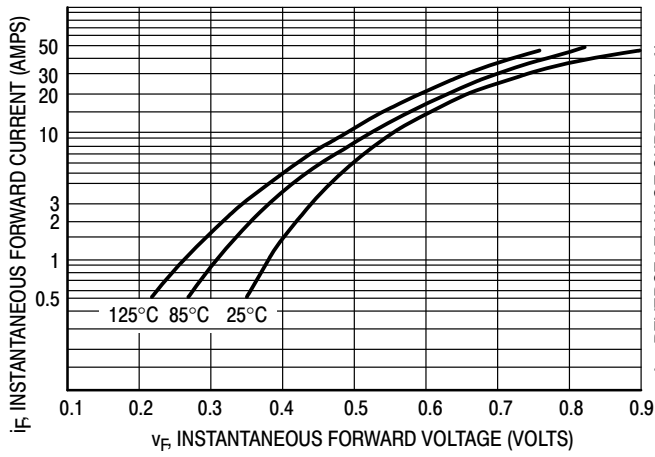


Figure 1. Typical Forward Voltage, Per Leg

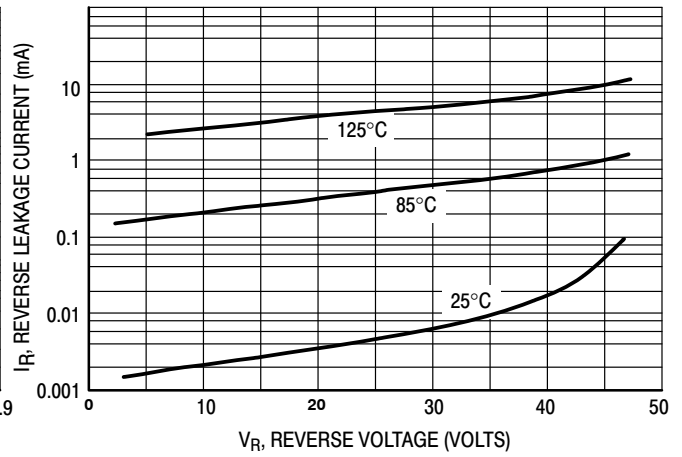


Figure 2. Typical Reverse Current, Per Leg

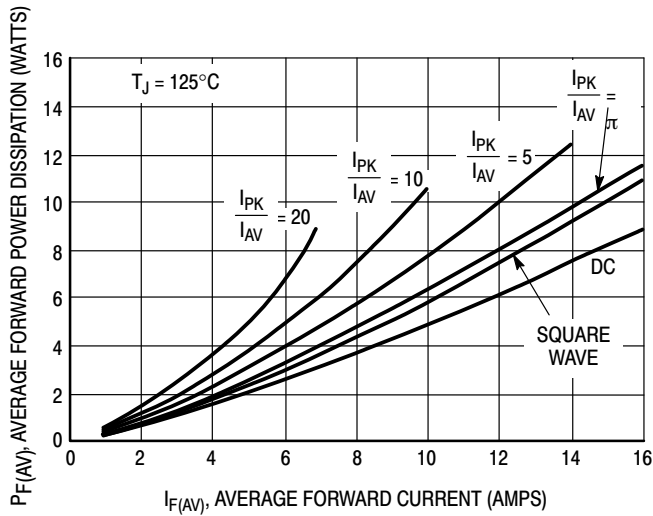


Figure 3. Typical Forward Power Dissipation

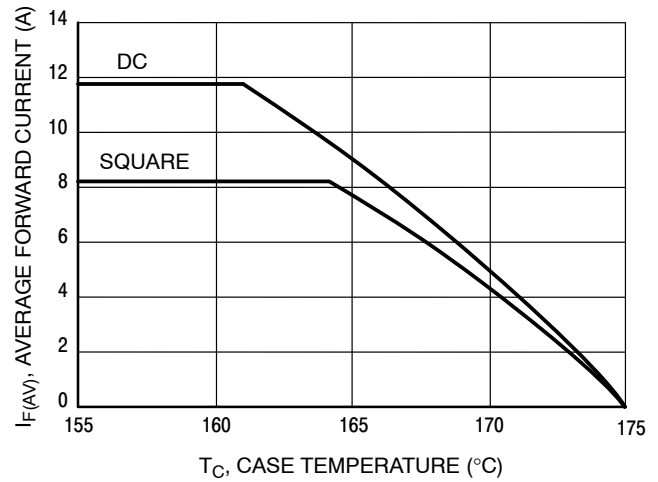
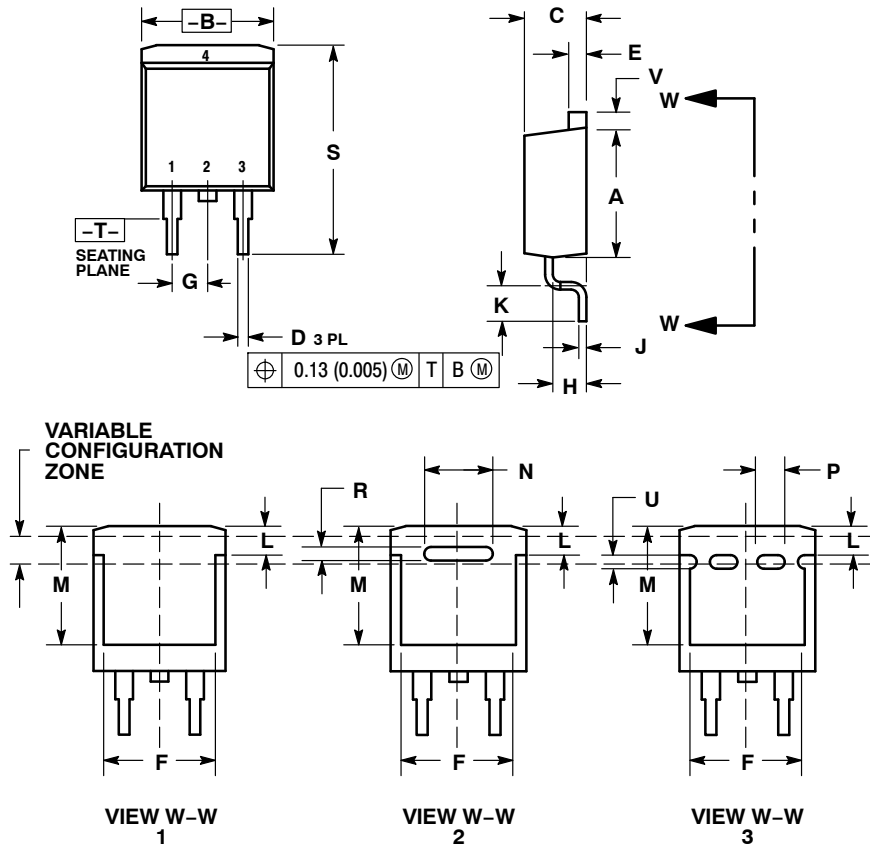


Figure 4. Current Derating, Case, Per Leg

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## PACKAGE DIMENSIONS

### D<sup>2</sup>PAK CASE 418B-04 ISSUE K



#### NOTES:

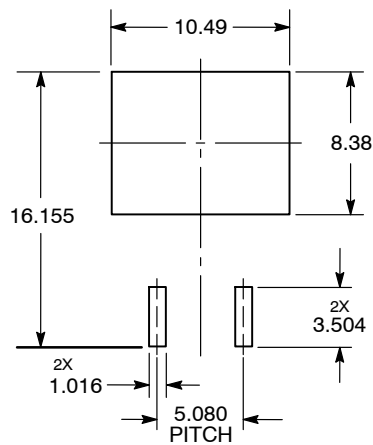
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. 418B-01 THRU 418B-03 OBSOLETE, NEW STANDARD 418B-04.

| DIM | INCHES    |       | MILLIMETERS |       |
|-----|-----------|-------|-------------|-------|
|     | MIN       | MAX   | MIN         | MAX   |
| A   | 0.340     | 0.380 | 8.64        | 9.65  |
| B   | 0.380     | 0.405 | 9.65        | 10.29 |
| C   | 0.160     | 0.190 | 4.06        | 4.83  |
| D   | 0.020     | 0.035 | 0.51        | 0.89  |
| E   | 0.045     | 0.055 | 1.14        | 1.40  |
| F   | 0.310     | 0.350 | 7.87        | 8.89  |
| G   | 0.100 BSC |       | 2.54 BSC    |       |
| H   | 0.080     | 0.110 | 2.03        | 2.79  |
| J   | 0.018     | 0.025 | 0.46        | 0.64  |
| K   | 0.090     | 0.110 | 2.29        | 2.79  |
| L   | 0.052     | 0.072 | 1.32        | 1.83  |
| M   | 0.280     | 0.320 | 7.11        | 8.13  |
| N   | 0.197 REF |       | 5.00 REF    |       |
| P   | 0.079 REF |       | 2.00 REF    |       |
| R   | 0.039 REF |       | 0.99 REF    |       |
| S   | 0.575     | 0.625 | 14.60       | 15.88 |
| V   | 0.045     | 0.055 | 1.14        | 1.40  |

#### STYLE 3:

- PIN 1. ANODE
- CATHODE
- ANODE
- CATHODE

### SOLDERING FOOTPRINT\*



DIMENSIONS: MILLIMETERS

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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